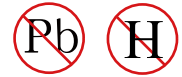


**YEA SHIN TECHNOLOGY CO., LTD****S52 THRU S525****SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER****VOLTAGE- 20 to 250 Volts CURRENT- 5.0 Amperes****Features**

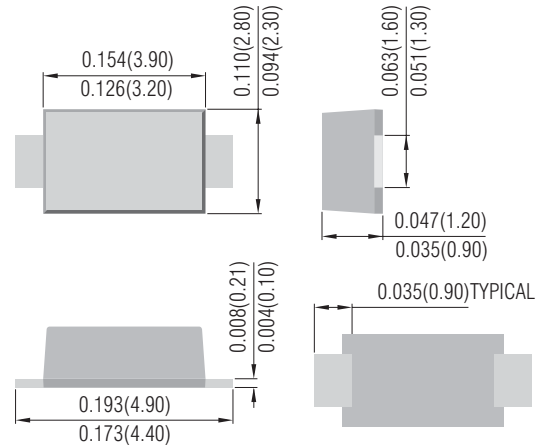
- Schottky Brrier Chip
- Low Power Loss,High Efficiency
- Ideally Suited for Automatic Assembly
- Surge Overload Rating to 110A Peak
- Plastic Case Material has UL Flammability Classification Rating 94V-0

**Mechanical Data**

- Case: Molded plastic SMF
- Terminals: Plated leads solderable per MIL-STD-750,Method 2026 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Making: Type Number

**SMF**

Unit:inch(mm)

**Maximum Ratings and Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified  
 Single phase,half wave,60Hz,resistive or inductive load  
 For capacitive load derate current by 20%

Type Number	SYMBOL	S52	S53	S54	S545	S55	S56	S58	S510	S515	S520	S525	Unit
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	20	30	40	45	50	60	80	100	150	200	250	V
Maximum RMS Voltage	V <sub>RMS</sub>	14	21	28	31	35	42	56	70	105	140	175	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	20	30	40	45	50	60	80	100	150	200	250	V
Average Rectified Output Current @T <sub>L</sub> =90°C	I <sub>F(AV)</sub>	5.0											A
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	110											A
I <sup>2</sup> t Rating for Fusing (t < 8.3ms)	I <sup>2</sup> t	50.215											A <sup>2</sup> s
Forward Voltage @IF=5.0A (Note 1)	V <sub>FM</sub>	0.50				0.67		0.82		0.90		0.92	V
Peak Reverse Current @T <sub>A</sub> =25 °C	I <sub>R</sub>	0.1						0.05					mA
At Rated DC Blocking Voltage @T <sub>A</sub> =100 °C		10						5					
Typical Junction Capacitance	C <sub>J</sub>	28											pF
Typical Thermal Resistance per leg (Note 2)	R <sub>θJA</sub>	88											°C/W
Operating Temperature Range	T <sub>J</sub>	-55 to+150											°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150											°C

Note: 1.Pulse Test with PW=300usec,1%Duty Cycle.

2.Mounted on P.C.Board with 5.0 mm<sup>2</sup> (0.13mm thick) copper pad areas.

# DEVICE CHARACTERISTICS

## S52 THRU S525

Fig. 1 Forward Current Derating Curve

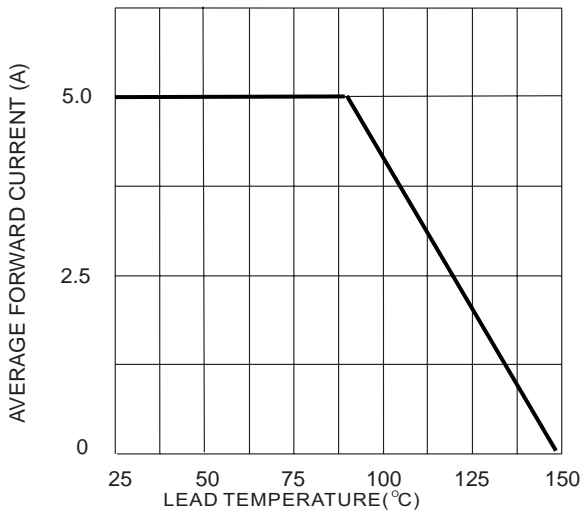


Fig. 2 Typ. Forward Characteristics

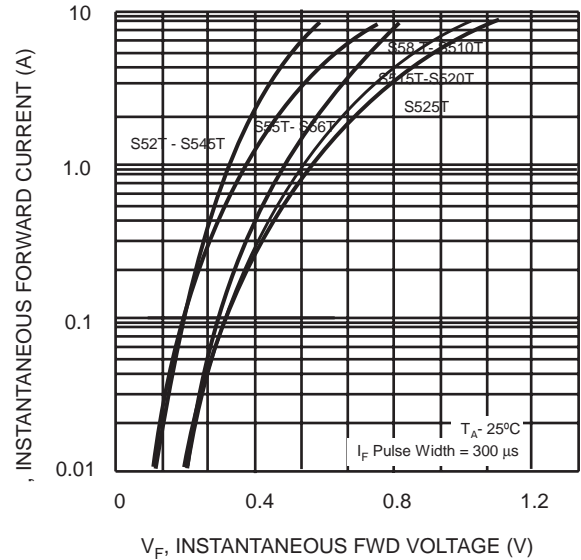


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

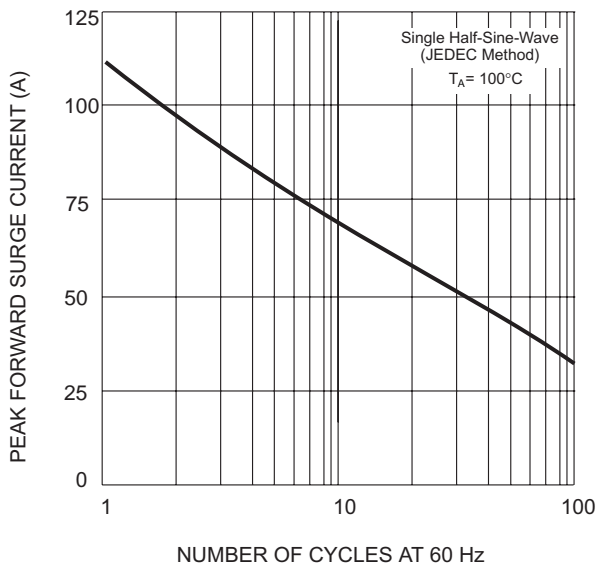


Fig. 4 Typical Reverse Characteristics (per element)

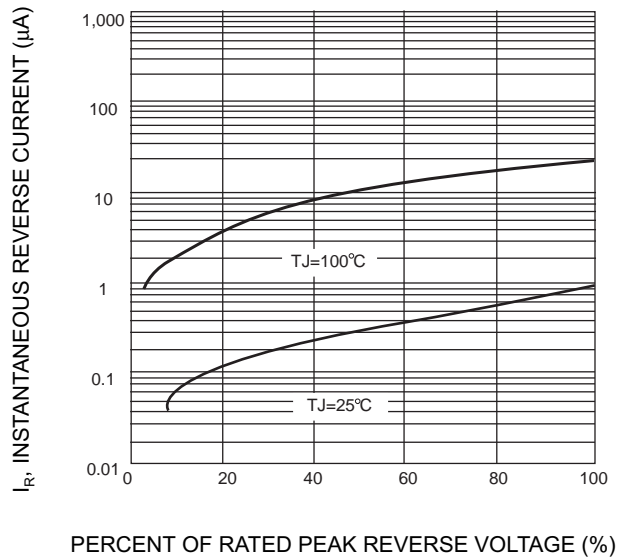


Fig.5 TYPICAL CAPACITANCE

